

General Description

The MAX4762-MAX4764/MAX4764A/MAX4765 dual SPDT (single-pole/double-throw) switches feature negative signal capability that allows signals below ground to pass through without distortion. These analog switches operate from a single +1.8V to +5.5V supply and have low 0.6Ω on-resistance, making them ideal for switching audio signals.

The MAX4763/MAX4765 include a comparator that can be used for headphone detection or a mute/send key function. The MAX4764/MAX4764A/MAX4765 have an internal shunt switch to automatically discharge any capacitance at the NO and NC connection points. This reduces click-and-pop sounds that occur when switching audio signals between precharged points.

These SPDT switches are available in space-saving µMAX®, TDFN, thin QFN, and UCSP™ packages and operate over the -40°C to +85°C extended temperature range.

Applications

Cell Phones PDAs and Handheld Devices Notebook Computers MP3 Players

µMAX is a registered trademark and UCSP is a trademark of Maxim Integrated Products, Inc.

Features

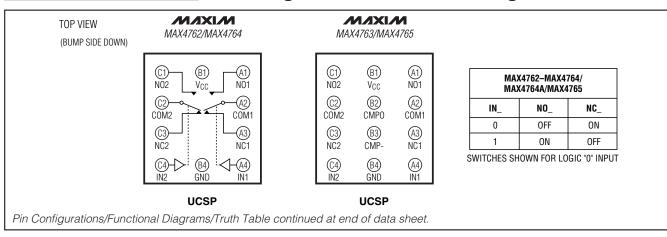
- **♦ Distortion-Free Negative Signal Throughput Down** to V_{CC} - 5.5V
- **♦** Comparator for Headphone or Mute Detection (MAX4763/MAX4765)
- ♦ Internal Shunt Resistor Reduces Click/Pop (MAX4764/MAX4764A/MAX4765)
- ♦ Low On-Resistance (RON) 0.6Ω at +2.7V Supply
- ♦ 0.25Ω On-Resistance Flatness
- ♦ 0.05Ω On-Resistance Matching
- ♦ +1.8V to +5.5V Supply Voltage
- ◆ -70dB Crosstalk (100kHz)
- ◆ -65dB Off-Isolation (100kHz)
- ♦ 0.01% Total Harmonic Distortion
- ♦ Available in µMAX, TDFN, Thin QFN, and UCSP **Packages**

Ordering Information

PART	TEMP RANGE	PIN- PACKAGE	TOP MARK
MAX4762ETB	-40°C to +85°C	10 TDFN	ACG
MAX4762EUB	-40°C to +85°C	10 μMAX	_
MAX4762EBC-T	-40°C to +85°C	12 UCSP-12	ABU

Ordering Information continued at end of data sheet. Selector Guide appears at end of data sheet.

Pin Configurations/Functional Diagrams/Truth Table



NIXIN

Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

(All voltages referenced to GND.)	
V _{CC} , IN_, CMP	-0.3V to +6.0V
COM_, NO_, NC(V _{CC} - 6V) to	$o(V_{CC} + 0.3V)$
CMPO0.3V to	$o(V_{CC} + 0.3V)$
Closed-Switch Continuous Current COM_, NO_, NO	
Open-Switch Continuous Current NO_, NC_	
(MAX4764/MAX4764A/MAX4765)	±30mA
Peak Current COM_, NO_, NC_	
(pulsed at 1ms, 50% duty cycle)	±300mA
Peak Current COM_, NO_, NC_	
(pulsed at 1ms, 10% duty cycle)	±400mA
Continuous Power Dissipation (T _A = +70°C)	
10-Pin TDFN (derate 24.4mW/°C above +70°C)1951mW
10-Pin µMAX (derate 5.6mW/°C above +70°C)	,
(

12-Bump UCSP (MAX4762/MAX4764)	
(derate 5.6mW/°C above +70°C)	449mW
12-Bump UCSP (MAX4763/MAX4765)	
(derate 6.5mW/°C above +70°C)	519mW
12-Pin Thin QFN (derate 16.9mW/°C abo	ove +70°C) 1349mW
ESD Method 3015.7	±2kV
Operating Temperature Range	40°C to +85°C
Junction Temperature	
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C
Bump Temperature (soldering)	
Infrared (15s)	+220°C
Vapor Phase (60s)	+215°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +2.7 \text{V to } +5.5 \text{V}, T_A = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}, \text{ unless otherwise noted.}$ Typical values are at $V_{CC} = +3.0 \text{V}, T_A = +25 ^{\circ}\text{C}, \text{ unless otherwise noted.}$ (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
ANALOG SWITCH							
Analog Signal Range (Note 2)	V _{NO_} , V _{NC_} , V _{COM_}			V _{CC} - 5.5		Vcc	V
On Desistance	D	$V_{CC} = 2.7V$; V_{NC} or $V_{NO} =$	$T_A = +25^{\circ}C$		0.6	0.85	
On-Resistance (Notes 3 and 4)	RON(NC), RON(NO)	V _{CC} - 5.5V, -1V, 0V, 1V, 2V, V _{CC} ; I _{COM} = 100mA	T _A = T _{MIN} to T _{MAX}			0.95	Ω
On-Resistance Match			$T_A = +25^{\circ}C$		0.05	0.1	
Between Channels (Notes 3, 4, and 5)	ΔR _{ON}	VCC = 2.7V, V _{NC} or V _{NO} = 0V, I _{COM} = 100mA	$T_A = T_{MIN}$ to T_{MAX}			0.15	Ω
0 0 : 1		$V_{CC} = 2.7V$; V_{NC} or $V_{NC} =$	$T_A = +25^{\circ}C$	0.25 0.4			
On-Resistance Flatness (Notes 4 and 6)	R _{FLAT(NC)}	-1V, 0V, 1V, 2V, V _{CC} ; I _{COM} _ = 100mA	$T_A = T_{MIN}$ to T_{MAX}			0.45	Ω
Shunt Switch Resistance	R _{SH}	MAX4764/MAX4764A/MAX4765 only, I _{NO_} or I _{NC_} = 10mA, V _{CC} = 2.7V	$T_A = T_{MIN}$ to T_{MAX}		25	50	Ω
NO_, NC_ Off-Leakage Current	I _{NO_(OFF),}	MAX4762/MAX4763 only (Note 7), VCC = 2.7V, switch open;	T _A = +25°C	-2		+2	nA
(Notes 8 and 9)	I _{NC_(OFF)}	V _{NC} or V _{NO} = -2.5V, +2.5V; V _{COM} = +2.5V, -2.5V	$T_A = T_{MIN}$ to T_{MAX}	-10		+10	TIA.
COM_ On-Leakage Current	loom (ON)	V _{CC} = 2.7V, switch closed; V _{NC} _ or V _{NO} _ = -2.5V, +2.5V, or	T _A = +25°C	-6		+6	nA
(Notes 8 and 9)	ICOM_(ON)	floating; $V_{COM} = -2.5V$, +2.5V, or floating	TA = T _{MIN} to T _{MAX}	-50		+50	TIA .

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ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = +2.7V \text{ to } +5.5V, T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$ Typical values are at $V_{CC} = +3.0V, T_A = +25^{\circ}\text{C}, \text{ unless otherwise noted.}$ (Note 1)

PARAMETER	SYMBOL	CONDITION	IS	MIN	TYP	MAX	UNITS
DYNAMIC CHARACTERIST	ics						
		$V_{CC} = 2.7V, V_{NO} = 1.5V;$ for	$T_A = +25^{\circ}C$		25	80	
Turn-On Time	tou	NO_{-} , V_{IN}_{-} = 0V to V_{CC} ; for	$T_A = T_{MIN}$ to T_{MAX}			80	no
Turn-On Time	ton	NC_, V_{IN} = V_{CC} to 0V; R_L = 300Ω , C_L = $35pF$, Figure 2	$T_A = T_{MIN}$ to T_{MAX} (MAX4764A)		225		ns
		$V_{CC} = 2.7V, V_{NC} = 1.5V;$ for	$T_A = +25^{\circ}C$		20	70	
Turn-Off Time	toff	NO_{-} , $V_{IN}_{-} = V_{CC}$ to $0V$; for	$T_A = T_{MIN}$ to T_{MAX}			70	ns
Turn on time	TOFF	NC_, V_{IN} = 0V to V_{CC} ; R_L = 300 Ω , C_L = 35pF, Figure 2	$T_A = T_{MIN}$ to T_{MAX} (MAX4764A)		225	500	110
Break-Before-Make Time Delay	t _D	$V_{CC} = 2.7V$, $V_{N_{-}} = 1.5V$, for NO_{-} , $V_{IN_{-}} = V_{CC}$ to 0V; for NC_{-} , $V_{IN_{-}} = 0V$ to V_{CC} ; $R_{L} = 300\Omega$, $C_{L} = 35pF$, Figure 3	T _A = +25°C	1	7		ns
Charge Injection	Q	V _{COM} _ = 0V, C _L = 1.0nF, Figure	re 4		150		рС
Off-Isolation (Note 10)	V _{ISO}	f = 100kHz, V _{COM} _ = 1V _{RMS} , I Figure 5	$R_L = 50\Omega$, $C_L = 5pF$,		-65		dB
Crosstalk	VCT	f = 100kHz, V _{COM} _ = 1V _{RMS} , I Figure 5		-70		dB	
Power-Supply Rejection Ratio	PSRR	f = 10kHz, V _{COM} _ = 1V _{RMS} , R		60		dB	
On-Channel -3dB Bandwidth	BW	Signal = 0dBm, $R_L = 50\Omega$, C_L	= 5pF, Figure 5		27		MHz
Total Harmonic Distortion	THD	$f = 20$ Hz to 20 kHz, $V_{COM} = 0$ $R_L = 32\Omega$.5V _{P-P} , DC Bias = 0,		0.01		%
NO_, NC_ Off-Capacitance	C _{NO_(OFF)} C _{NC_(OFF)}	f = 1MHz, V _{COM} _ = 0.5V _{P-P} , D	C Bias = 0, Figure 6		50		рF
COM On-Capacitance	CCOM_(ON)	f = 1MHz, V _{COM} _ = 0.5V _{P-P} , D	C Bias = 0, Figure 6		200		рF
DIGITAL I/O (IN_)							
		$V_{CC} = 2.7V \text{ to } 3.6V$		1.4			
Input-Logic High Voltage	VIH	$V_{CC} = 4.2V \text{ to } 5.5V$		2.0			V
		$V_{CC} = 2.7V \text{ to } 5.5V \text{ (MAX4764)}$	4 only)	1.6			
		$V_{CC} = 2.7V \text{ to } 3.6V$				0.5	
Input-Logic Low Voltage	VIL	$V_{CC} = 4.2V \text{ to } 5.5V$				0.8	V
		$V_{CC} = 2.7V \text{ to } 5.5V \text{ (MAX4764)}$	4 only)			0.5	
Input Leakage Current	I _{IN}	V_{IN} = 0V or V_{CC}		-1		+1	μΑ
COMPARATOR (MAX4763/I	MAX4765)		Т				Т
Comparator Threshold					V _{CC} / 3		V

ELECTRICAL CHARACTERISTICS (continued)

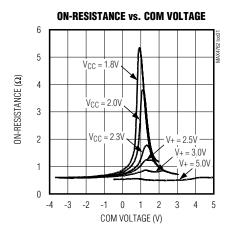
 $(V_{CC} = +2.7 \text{V to } +5.5 \text{V}, T_A = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}, \text{ unless otherwise noted.} \text{ Typical values are at } V_{CC} = +3.0 \text{V}, T_A = +25 ^{\circ}\text{C}, \text{ unless otherwise noted.})$ (Note 1)

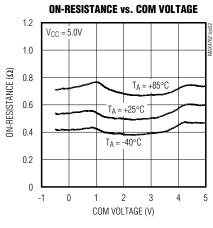
PARAMETER	SYMBOL	CONDITI	ONS	MIN	TYP	MAX	UNITS
Comparator Output High Voltage		ISOURCE = 1mA		V _{CC} - 0.4V			>
Comparator Output Low Voltage		ISINK = 1mA				0.4V	V
Comparator Input Leakage Current		V _{CMP-} = 0 to 2.7V		-100		+100	nA
Comparator Switching Time		V _{CC} = 2.7V, V _{CMP} - = 0V to V from 50% of V _{CMP} - to 50% of			1	2	μs
POWER SUPPLY							
Power-Supply Range	V _C C			1.8		5.5	V
			MAX4763/MAX4765		5	10	
Constant Constant		$V_{CC} = 5.5V$, $V_{IN} = 0V$ or V_{CC}	MAX4762/MAX4764/ MAX4764A		0.01	1	
Supply Current	l+	V _{CC} = 5.5V, V _{IN} _ = 1.8V	MAX4764A		5	10	μΑ
		V _{CC} = 4.2V, V _{IN} = 1.8V (Note 11)	MAX4764A		2	5	

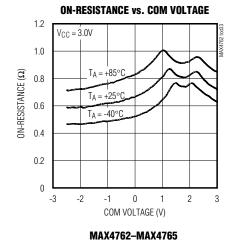
- Note 1: UCSP and TDFN parts are 100% tested at T_A = +25°C only, and guaranteed by design over the specified temperature range. Thin QFN parts are 100% tested at T_A = +85°C only, and guaranteed by design over the specified temperature range.
- Note 2: Signals on COM_, NO_, or NC_ exceeding VCC are clamped by internal diodes. Limit forward-diode current to maximum current rating.
- Note 3: Thin QFN and UCSP are guaranteed by design; not production tested.
- Note 4: I_{COM} for UCSP is 10mA.
- Note 5: $\Delta R_{ON} = R_{ON(MAX)} R_{ON(MIN)}$.
- **Note 6:** Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.
- Note 7: MAX4764/MAX4764A/MAX4765 have an internal shunt switch when in off-state, which determines OFF current.
- Note 8: Leakage parameters are 100% tested at maximum-rated hot operating temperature and guaranteed by design at T_A = +25°C.
- Note 9: UCSP parts are guaranteed by design.
- Note 10: Off-isolation = 20log₁₀ (V_{COM} / V_{NO}), V_{COM} = output, V_{NO} = input to off switch.
- Note 11: Guaranteed by design, not production tested.

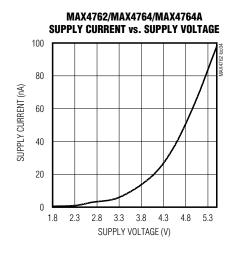
Typical Operating Characteristics

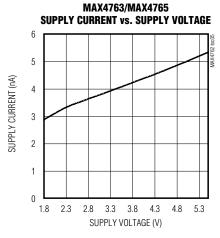
($V_{CC} = 3.0V$, $T_A = +25$ °C, unless otherwise noted.)

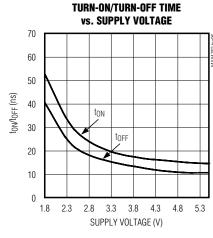


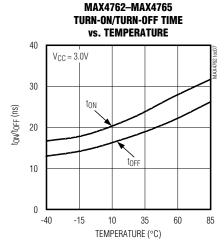


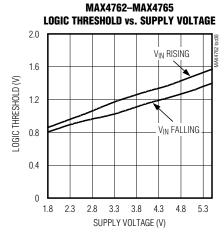


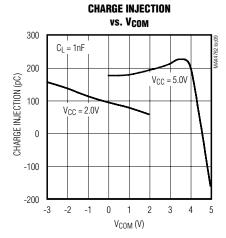






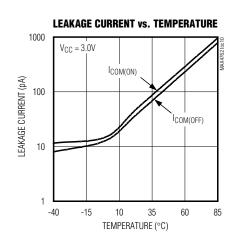


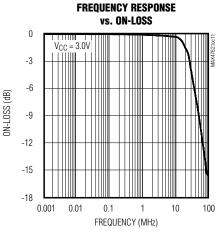


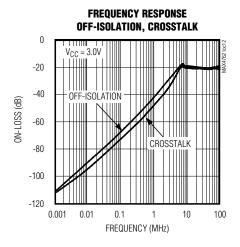


_Typical Operating Characteristics (continued)

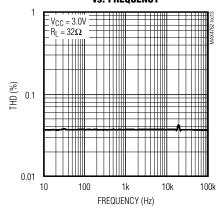
(V_{CC} = 3.0V, T_A = +25°C, unless otherwise noted.)



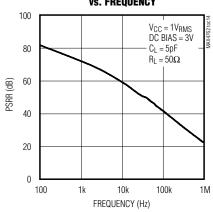




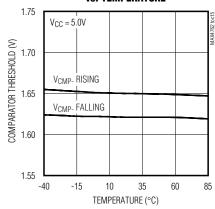
TOTAL HARMONIC DISTORTION vs. FREQUENCY



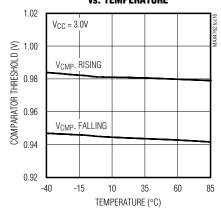
POWER-SUPPLY REJECTION RATIO vs. FREQUENCY



COMPARATOR THRESHOLD vs. TEMPERATURE



COMPARATOR THRESHOLD vs. TEMPERATURE



Pin Description (MAX4762/MAX4764/MAX4764A)

Pi	IN		
10-μMAX 10-TDFN	12-UCSP	NAME	FUNCTION
1	B1	Vcc	Positive-Supply Voltage Input
2	A1	NO1	Analog Switch 1—Normally Open Terminal
3	A2	COM1	Analog Switch 1—Common Terminal
4	А3	NC1	Analog Switch 1—Normally Closed Terminal
5	A4	IN1	Digital Control Input for Analog Switch 1. A logic LOW on IN1 connects COM1 to NC1 and a logic HIGH connects COM1 to NO1.
6	B4	GND	Ground
7	C4	IN2	Digital Control Input for Analog Switch 2. A logic LOW on IN2 connects COM2 to NC2 and a logic HIGH connects COM2 to NO2.
8	C3	NC2	Analog Switch 2—Normally Closed Terminal
9	C2	COM2	Analog Switch 2—Common Terminal
10	C1	NO2	Analog Switch 2—Normally Open Terminal
EP (TDFN only)	_	EP	Exposed pad for TDFN package. Connect to GND.

Pin Description (MAX4763/MAX4765)

Р	QFN 12-UCSP 1 A2 2 A3 3 A4	PIN						
12-Thin QFN	12-UCSP	NAME	FUNCTION					
1	A2	COM1	Analog Switch 1—Common Terminal					
2	A3	NC1	Analog Switch 1—Normally Closed Terminal					
3	A4	IN1	Digital Control Input for Analog Switch 1. A logic LOW on IN1 connects COM1 to NC1 and a logic HIGH connects COM1 to NO1.					
4	В3	CMP-	Comparator Inverting Input					
5	B4	GND	Ground					
6	C4	IN2	Digital Control Input for Analog Switch 2. A logic LOW on IN2 connects COM2 to NC2 and a logic HIGH connects COM2 to NO2.					
7	C3	NC2	Analog Switch 2—Normally Closed Terminal					
8	C2	COM2	Analog Switch 2—Common Terminal					
9	C1	NO2	Analog Switch 2—Normally Open Terminal					
10	B2	CMPO	Comparator Output					
11	B1	Vcc	Positive-Supply Voltage Input					
12	A1	NO1	Analog Switch 1—Normally Open Terminal					
EP	_	EP	Exposed pad. Connect to GND.					

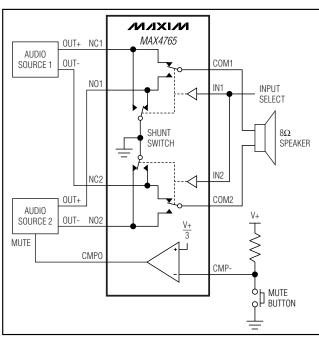


Figure 1. Typical Operating Circuit

Detailed Description

The MAX4762–MAX4764/MAX4764A/MAX4765 are low on-resistance, low-voltage, dual SPDT analog switches that operate from a +1.8V to +5.5V supply and are fully specified for nominal 3.0V applications. The devices feature a negative signal capability that allows signals below ground to pass through without distortion and have break-before-make switching.

The MAX4763/MAX4765 feature a comparator that can be used for headphone or mute detection. The comparator threshold is internally generated to be approximately 1/3 of V_{CC}. The MAX4764/MAX4764A/MAX4765 feature an internal shunt switch to discharge any capacitance at the NO and NC connection points. This reduces the clickand-pop sounds that occur when switching audio signals.

_Applications Information

Digital Control Inputs

The MAX4762–MAX4764/MAX4764A/MAX4765 logic inputs accept up to +5.5V, regardless of supply voltage. For example, with a +3.3V supply, IN_ can be driven low to GND and high to +5.5V allowing for mixing of logic levels in a system. Driving IN_ rail-to-rail minimizes power consumption. For a +1.8V supply voltage, the logic thresholds are 0.5V (low) and 1.4V (high); for a +5V supply voltage, the logic thresholds are 0.8V (low) and 2.0V (high).

Analog Signal Levels

The on-resistance of the MAX4762-MAX4764/MAX4764A/MAX4765 changes very little for analog input signals across the entire supply voltage range (see the *Typical Operating Characteristics*). The switches are bidirectional, so the NO_, NC_, and COM_ pins can be either inputs or outputs.

The MAX4762–MAX4764/MAX4764A/MAX4765 pass signals as low as V_{CC} - 5.5V, including signals below ground with minimal distortion.

Comparator (MAX4763/MAX4765)

The MAX4763/MAX4765 include a comparator that can be used for mute and headphone detection functions. The positive terminal of the comparator is internally set to VCC / 3. When the negative terminal (CMP-) is below the threshold, the comparator output (CMPO) is a logic high. When CMP- rises above VCC / 3, CMPO is a logic low.

The comparator threshold of V_{CC} / 3 allows for detection of headphones because headphone audio signals are typically biased to V_{CC} / 2.

Shunt Switch (MAX4764/MAX4764)

The 100Ω shunt switches on the MAX4764/MAX4764A/MAX4765 automatically discharge any capacitance at the NC_ or NO_ terminals when they are unconnected to COM_. This reduces audible click-and-pop sounds that occur when switching between audio sources.

Audible clicks and pops are caused when a step DC voltage is switched into the speaker. By automatically discharging the side that is not connected, any residual DC voltage is removed, thereby reducing the clicks and pops.

Power-Supply Sequencing and Overvoltage Protection

Caution: Do not exceed the absolute maximum ratings since stresses beyond the listed ratings may cause permanent damage to the device.

Proper power-supply sequencing is recommended for all CMOS devices. Always apply VCC before applying analog signals, especially if the analog signal is not current-limited.

_UCSP Applications Information

For the latest application details on UCSP construction, dimensions, tape carrier information, printed circuit board techniques, bump-pad layout, and recommended reflow temperature profile, as well as the latest information on reliability testing results, go to the Maxim's website at www.maxim-ic.com/ucsp and search for the Application Note, "UCSP—A Wafer-Level Chip-Scale Package."

Test Circuits/Timing Diagrams

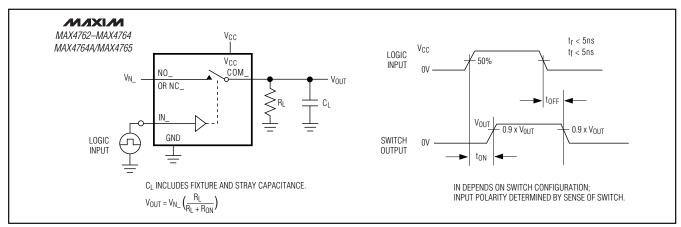


Figure 2. Switching Time

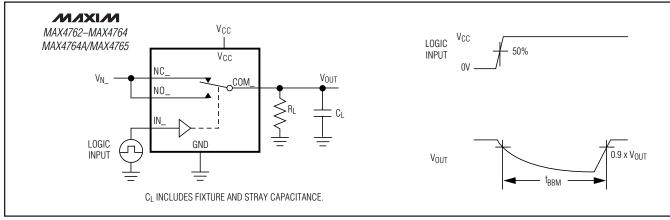


Figure 3. Break-Before-Make Interval

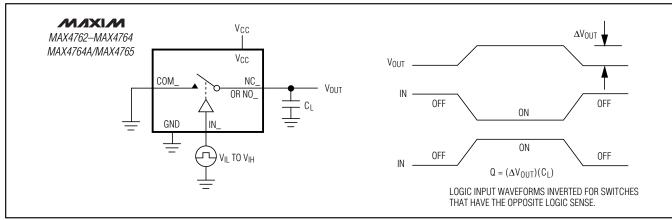


Figure 4. Charge Injection

Test Circuits/Timing Diagrams (continued)

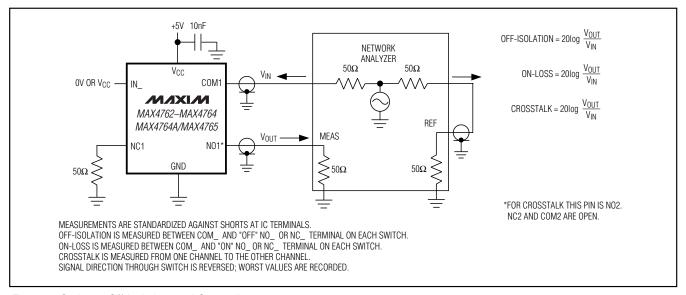


Figure 5. On-Loss, Off-Isolation, and Crosstalk

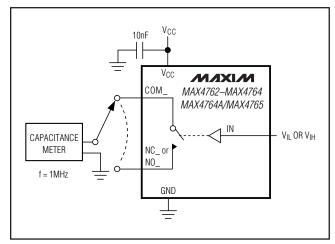
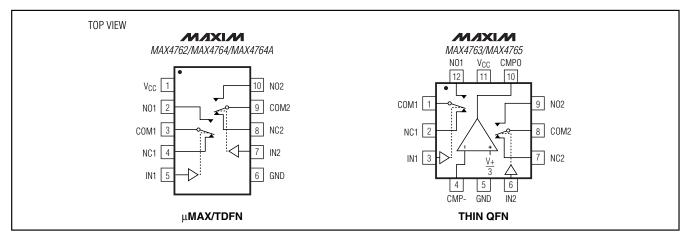


Figure 6. Channel Off/On-Capacitance

Pin Configurations/Functional Diagrams/Truth Table (continued)



Selector Guide

PART	COMPARATOR	SHUNT	PACKAGE SIZE (mm)
MAX4762EBC-T	No	No	1.5 x 2.0
MAX4762ETB	No	No	3.0 x 3.0
MAX4762EUB	No	No	3.0 x 5.0
MAX4763EBC-T	Yes	No	1.5 x 2.0
MAX4763ETC	Yes	No	4.0 x 4.0
MAX4764EBC-T	No	Yes	1.5 x 2.0
MAX4764ETB	No	Yes	3.0 x 3.0
MAX4764AETB	No	Yes	3.0 x 3.0
MAX4764EUB	No	Yes	3.0 x 5.0
MAX4765EBC-T	Yes	Yes	1.5 x 2.0
MAX4765ETC	Yes	Yes	4.0 x 4.0

Ordering Information (continued)

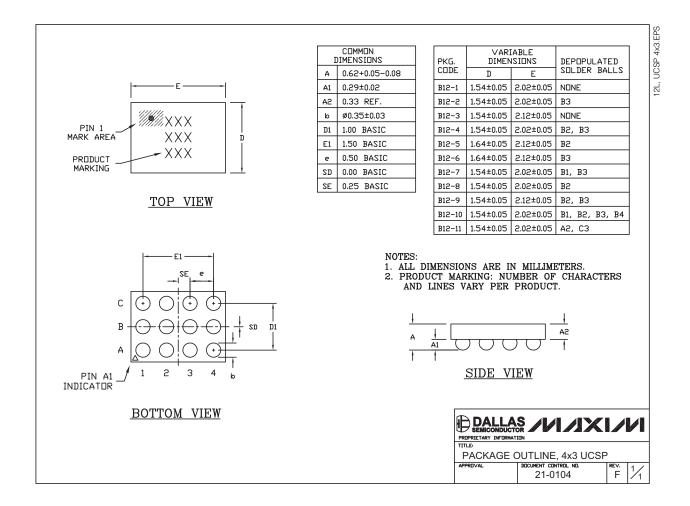
PART	TEMP RANGE	PIN- PACKAGE	TOP MARK
MAX4763EBC-T	-40°C to +85°C	12 UCSP-12	ABS
MAX4763ETC	-40°C to +85°C	12 Thin QFN	AAED
MAX4764ETB	-40°C to +85°C	10 TDFN	ACH
MAX4764EUB	-40°C to +85°C	10 μMAX	_
MAX4764EBC-T	-40°C to +85°C	12 UCSP-12	ABV
MAX4764AETB	-40°C to +85°C	10 TDFN	AQP
MAX4765EBC-T	-40°C to +85°C	12 UCSP-12	ABT
MAX4765ETC	-40°C to +85°C	12 Thin QFN	AAEE

Chip Information

TRANSISTOR COUNT: 769 PROCESS: BICMOS

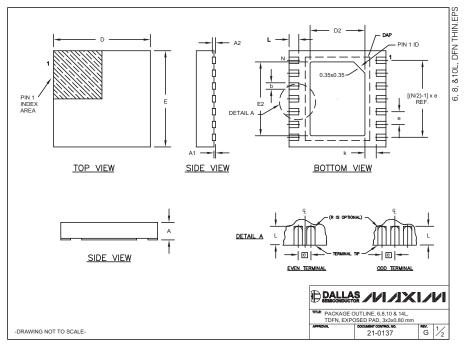
Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



Package Information (continued)

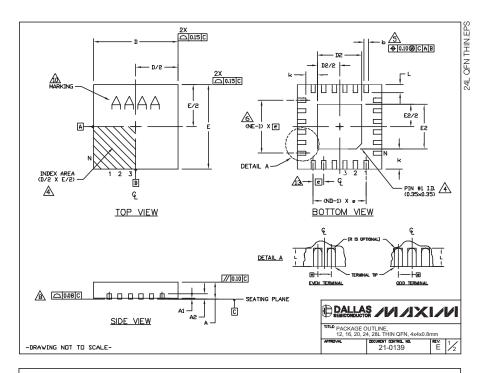
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



CC	OMMON	DIMEN	NSIONS								
SYM	BOL	MIN.	MAX.	1							
А	$\overline{}$	0.70	0.80]							
D	\rightarrow	2.90	3.10								
E	$\overline{}$	2.90	3.10								
A.	1	0.00	0.05	-							
k k	\dashv		5 MIN.	1							
A	2		0 REF.	1							
		T10110								1	
PACKAGE	_								DOWNBONDS	-	
PKG. COD	E	N	D2	E2	е	JEDEC SPEC	b	[(N/2)-1] x e	ALLOWED	4	
T633-1	_	-	1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF	NO	1	
T633-2	_		1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF	NO	1	
T833-1		8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF	NO]	
T833-2		8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF	NO]	
T833-3		8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF	YES]	
T1033-1		10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF	NO]	
T1433-1		14	1.70±0.10	2.30±0.10	0.40 BSC		0.20±0.05	2.40 REF	YES]	
T1433-2		14	1.70±0.10	2.30±0.10	0.40 BSC		0.20±0.05	2.40 REF	NO		
2. COPLAN 3. WARPAG 4. PACKAG SPECIA	IARITY SE SHA SE LEN SL CHA G CON	SHALL NO GTH/PA RACTER IFORMS	NOT EXCI T EXCEED ACKAGE W RISTIC(S). TO JEDE	ANGLES IN EED 0.08 n 0.10 mm. DTH ARE C	onsidered	AS ENSIONS "D2" ANI) "E2",	Ð	NALI AC	48 48 48 2	71
	1433-		1433-2.					ı.	EMICONDUCTOR	/VI/I)	
		OTAL N									

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



				CUMI	4III	DIME	11/211	7IN 2								
PKG	12	L 4x	4	16L 4×4			20	L 4x	4	2.	4L 4×	4	28L 4x4			
REF.	MIN.	NDM.	MAX.	MIN.	MIN. NOM. MAX.		MIN.	NDM.	MAX.	MIN.	NDN.	MAX.	MIN.	NDM.	MAX	
٨	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.90	0.70	0.75	0.80	0.70	0.75	0.80	
A1	0.0	0.02	0.05	0.0	20.0	0.05	0.0	0.02	0.05	0.0	0.02	0.05	0.0	20.0	0.05	
A2	0.20 REF			0	.20 RE	F	0	20 RE	F	0.20 REF			0	20 RE	F	
b	0.25	0.30	0.35	0.25	0.30	0.35	0.20	0.25	0.30	0.18	0.23	0.30	0.15	0.20	0.25	
D	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	
E	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	
e		0.80 BS	C.	0.65 BSC.		0.50 BSC.		0.50 BSC.			0.40 BSC.					
k	0.25	-	-	0.25	-	-	0.25	-	-	0.25	-	-	0.25	-	-	
L	0.45	0.55	0.65	0.45	0.55	0.65	0.45	0.55	0.65	0.30	0.40	0.50	0.30	0.40	0.50	
N		12			16			50		24			28			
ND		3			4			5			6			7		
NE		3			4			5			6			7		
Jedec Var.		WGGB			WGGC		١ .	/GGD-	1		WGGD-	-2		WGGE		

PKG.	1)2			E5			DOWN BONDS
CODES	MIN.	NOM.	MAX.	MIN.	NDM.	MAX.	ALLOVED
T1244-3	1.95	2.10	2.25	1.95	2.10	2.25	YES
T1244-4	1.95	2.10	2.25	1.95	2.10	2.25	NO
T1644-3	1.95	2.10	2.25	1.95	2.10	2.25	YES
T1644-4	1.95	2.10	2.25	1.95	2.10	2.25	NO
T2044-2	1.95	2.10	2.25	1.95	2.10	2.25	YES
T2044-3	1.95	2.10	2.25	1.95	2.10	2.25	NO
T2444-2	1.95	2.10	2.25	1.95	2.10	2.25	YES
T2444-3	2.45	2.60	2.63	2.45	2.60	2.63	YES
T2444-4	2.45	2.60	2.63	2.45	2.60	2.63	NO
T2844-1	2.50	2.60	2.70	2.50	2.60	2.70	ND

- IESS DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES. N IS THE TOTAL NUMBER OF TERMINALS.

- DIMENSION IS APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25 mm AND 0.30 mm FROM TERMINAL TIP.
- AND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
- COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
- 9. DRAWING CONFORMS TO JEDEC MO220, EXCEPT FOR T2444-3, T2444-4 AND T2844-1.

 MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.
- 11. COPLANARITY SHALL NOT EXCEED 0.08mm WARPAGE SHALL NOT EXCEEND 0.10mm
- 12. WARPAGE SHALL NOT EXCEEND 0.10mm

 A LEAD CENTERLINES TO BE AT TRUE POSITION AS DEFINED BY BASIC DIMENSION "6", ±0.05.

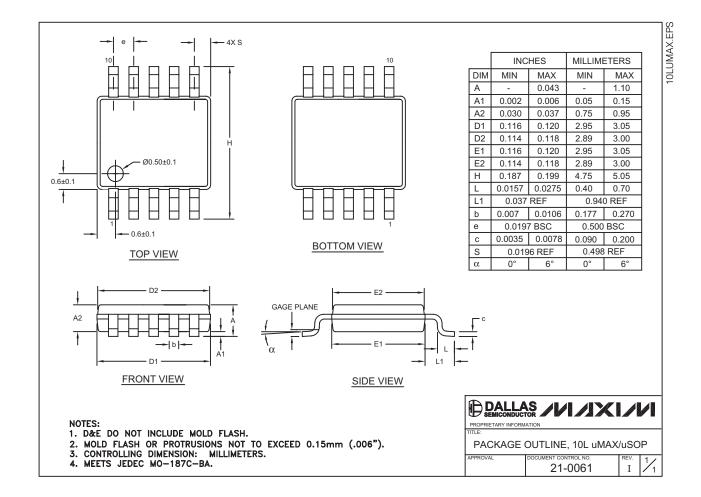
 14. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY

-DRAWING NOT TO SCALE-

DALL		(1/	
PACKAGE 12, 16, 20	OUTLINE, , 24, 28L THIN QFN, 4x4x	:0.8mm	
APPROVAL	21-0139	REV.	2/2

Package Information (continued)

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PI5A3166TAEX FSA634UCX XS3A1T3157GMX TC4066BP(N,F) DG302BDJ-E3 PI5A100QEX HV2605FG-G HV2301FG-G
RS2117YUTQK10 RS2118YUTQK10 RS2227XUTQK10 ADG452BRZ-REEL7 MAX4066ESD+ MAX391CPE+ MAX4730EXT+T
MAX314CPE+ BU4066BCFV-E2 MAX313CPE+ BU4S66G2-TR NLASB3157MTR2G TS3A4751PWR NLAS4157DFT2G
NLAST4599DFT2G NLAST4599DTT1G DG419LDY+T DG300BDJ-E3 DG2503DB-T2-GE1 TC4W53FU(TE12L,F) HV2201FG-G
74HC2G66DC.125 DG3257DN-T1-GE4 ADG1611BRUZ-REEL7 DG2535EDQ-T1-GE3 LTC201ACN#PBF 74LV4066DB,118